



www.lumentum.com Data Sheet

The EPM 705 series are high quality analog photodetectors designed for return path AM CATV applications. These coaxial modules are optically aligned to optimize performance and balance the parameters of responsivity, distortion and back reflection.

The photodetector die is fabricated with a proprietary InGaAs process in our wafer fab and assembled into a hermetically-sealed package with an antireflective-coated lens. A stainless steel bushing is used to actively couple the fiber to the package.

The fiber is reinforced with a rubber boot which relieves fiber bending stresses. The EPM 705 series can be produced without a connector or with a variety of industry standard connectors. They are also available with a mounting bracket which allows both vertical panel mounting and horizontal flush-to-board mounting.

Kev Features

- Electro-optical
 - Low intermodulation distortion
 - High responsivity
 - Low back reflection
- Packaging
 - Single mode 900 µm fiber with or without a connector
 - Single mode 250 µm fiber without a connector

Applications

- AM fiber optic CATV receivers to 550 MHz (EPM 705)
- Multi-channel fiber optic transmission

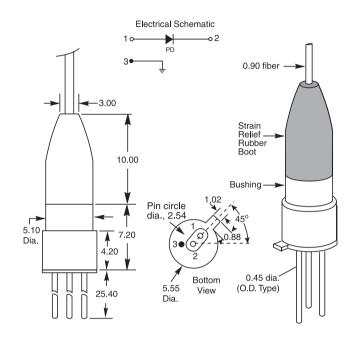
Dimensions Diagram

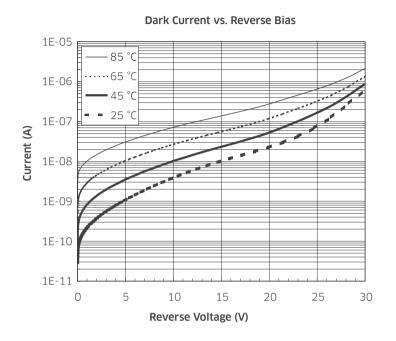
(Specifications in mm unless otherwise noted.)

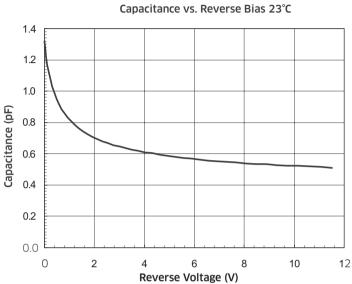
EPM 705 with Dual Mount Bracket

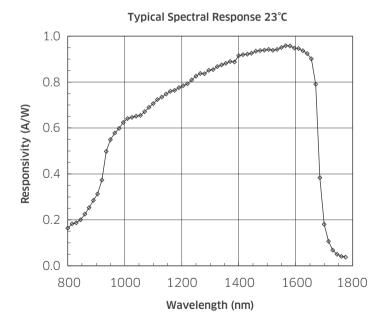
Electrical Schematic PD 0.90 fiber -17.20 5.10 Dia Strain Relief -Rubber Boot 25.40 5.60 Dia. 17.00 Bottom 12.00 View 0.45 dia. (O.D. Type) 3.70 V Pin circle Dia., 2.54 8.50

EPM 705 without Dual Mount Bracket









Specifications

(Temperature = 25° C, $V_0 = 5$ V unless noted. All specifications without connector.)

Parameter	Conditions		EPM 705
Responsivity	λ= 1310 nm	Minimum	0.80 A/W
	λ = 1550 nm	Minimum	0.85 A/W
Distortion product IM ₂		Maximum	-70 dBc1
Back reflection		Maximum	-40 dB
Dark current		Maximum	5.0 nA
Capacitance ³		Maximum	0.75 pF
Bandwidth ⁴		Typical	2.0 GHz
Single mode fiber 900 μm 8.7/125 μm core/cladding		Minimum	1.0 m
		Maximum	1.5 m

- 1. IM_2 measured at V_R = 12 V, P_{avg} = 0 dBm, MI = 0.7, R_{load} = 50 Ω , f_1 + f_2 = 324.25 MHz, f_1 f_2 = 54.25 MHz. 2. IM_2 measured at V_R = 12 V, P_{avg} = 0 dBm, MI = 0.7, R_{load} = 50 Ω , f_1 + f_2 = 850.25 MHz, f_1 f_2 = 50.25 MHz.
- 3. Measured with case grounded.
- 4. -3 dB point into a 50 Ω load.

Maximum Ratings

Parameter		Specification		
Forward current ¹	Minimum	10 mA		
Reverse current ²	Minimum	10 mA		
Reverse voltage	Minimum	25 V		
Power dissipation	Minimum	100 mW		
Operating case temperature	Minimum	-40°C		
	Maximum	85°C		
Soldering temperature	Minimum	260°C		
Storage temperature	Minimum	-40°C		
	Maximum	85°C		

- 1. Under forward bias, current at which device may be damaged.
- 2. Under reverse bias, current at which device may be damaged.

Precautions for Use

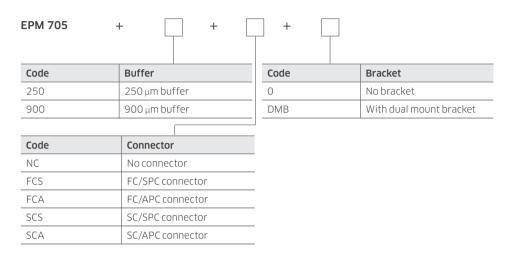
ESD protection is imperative. Use of grounding straps, anti-static mats, and other standard ESD protective equipment is recommended when handling or testing an InGaAs PIN or any other junction photodiode.

Soldering temperature of the leads should not exceed 260°C for more than 10 seconds.

Fiber pigtails should be handled with less than 10 N pull and with a bending radius greater than 1 inch

Ordering Information

For more information on this or other products and their availability, please contact your local Lumentum account manager or Lumentum directly at customer.service@lumentum.com.





North America Toll Free: 844 810 LITE (5483)

Outside North America Toll Free: 800 000 LITE (5483)

China Toll Free: 400 120 LITE (5483)

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